

# FGH20N60UFD 600 V, 20 A Field Stop IGBT

### Features

- High Current Capability
- Low Saturation Voltage: V<sub>CE(sat)</sub> =1.8 V @ I<sub>C</sub> = 20 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

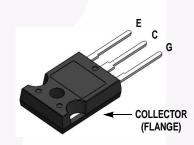
## Applications

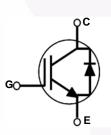
• Solar Inverter, UPS, Welder, PFC

March 2015

# **General Description**

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





### **Absolute Maximum Ratings**

Symbol	Description	Ratings	Unit	
V <sub>CES</sub>	Collector to Emitter Voltage	600	V	
V	Gate to Emitter Voltage	±20	V	
V <sub>GES</sub>	Transient Gate-to-Emitter Voltage	±30	V	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	40	A
'U	Collector Current	20	А	
I <sub>CM (1)</sub>	Pulsed Collector Current@ $T_C = 25^{\circ}C$		60	А
IF	Diode Forward Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	20	А
'F	Diode Forward Current	10	А	
I <sub>FM (1)</sub>	Pulsed Diode Maximum Forward Cu	60	А	
P <sub>D</sub> Maximum Power Dissipation		@ T <sub>C</sub> = 25 <sup>o</sup> C	165	W
. D	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	66	W
TJ	Operating Junction Temperature	-55 to +150	°C	
T <sub>stg</sub>	Storage Temperature Range	-55 to +150	°C	
Τ <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 second	300	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Part Nu	Part Number Top Mark Package		Packing Method	Reel Size	Т	ape Wid	lth Q	Quantity	
FGH20N60UFDTU FGH20N60UFD TO-247			Tube	N/A		N/A		30	
Electric	al Ch	aracteristics	s of the IC	<b>GBT</b> $T_{C} = 25^{\circ}C$ unless other	wise noted				
Symbol		Parameter	•	Test Conditio	ns M	in.	Тур.	Max.	Unit
-	Ļ						ļ		
Off Charac	1								
BV <sub>CES</sub>		or to Emitter Breako	-	$V_{GE} = 0 V, I_{C} = 250 \mu A$		00	-	-	V
$\Delta BV_{CES}$ / $\Delta T_{J}$	Temper Voltage	ature Coefficient of	Breakdown	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \mu\text{A}$		-		-	V/ºC
I <sub>CES</sub>	Collecto	or Cut-Off Current		$V_{CE} = V_{CES}, V_{GE} = 0 V$		-		250	μA
I <sub>GES</sub>	G-E Le	akage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$				±400	nA
On Charac	teristics								
V <sub>GE(th)</sub>	1	reshold Voltage		I <sub>C</sub> = 250 μA, V <sub>CE</sub> = V <sub>GE</sub>	4	.0	5.0	6.5	V
0=(11)		5		$I_{\rm C} = 20$ A, $V_{\rm GF} = 15$ V		-	1.8	2.4	V
V <sub>CE(sat)</sub>	Collecto	or to Emitter Satura	tion Voltage	$I_{C} = 20 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$		-	2.0	-	V
Dynamic C	1						0.40	_	~
C <sub>ies</sub>	-	apacitance		V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V,		-	940	-	pF
C <sub>oes</sub>	-			f = 1 MHz		-	110	-	pF
C <sub>res</sub>	Revers	e Transfer Capacita	ance			-	40	-	pF
Switching	Charact	eristics							
t <sub>d(on)</sub>	Turn-On Delay Time				-	13	-	ns	
t <sub>r</sub>	Rise Ti	Rise Time		-		-	17	-	ns
t <sub>d(off)</sub>	Turn-O	ff Delay Time		V <sub>CC</sub> = 400 V, I <sub>C</sub> = 20 A,		-	87	-	ns
t <sub>f</sub>	Fall Tim			$R_G = 10 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 25^{\circ}C$		-	32	64	ns
Eon	Turn-O					-	0.38	-	mJ
E <sub>off</sub>	Turn-O	ff Switching Loss				-	0.26	-	mJ
E <sub>ts</sub>	Total Sv	witching Loss		-		- /	0.64	-	mJ
t <sub>d(on)</sub>	Turn-O	n Delay Time				_	13	- /	ns
t <sub>r</sub>	Rise Ti	me				-	16	-	ns
t <sub>d(off)</sub>	Turn-O	ff Delay Time		V <sub>CC</sub> = 400 V, I <sub>C</sub> = 20 A,		-	92	-	ns
t <sub>f</sub>	Fall Tim	ne		$R_{G} = 10 \Omega$ , $V_{GE} = 15 V$ ,	-0.0	-	63	-	ns
E <sub>on</sub>	Turn-O	n Switching Loss		Inductive Load, T <sub>C</sub> = 125	5.6	-	0.41	- /	mJ
E <sub>off</sub>	Turn-O	ff Switching Loss				-	0.36	-	mJ
E <sub>ts</sub>	Total Sv	witching Loss				-	0.77	- \	mJ
Qg	Total G	ate Charge				-	63	-	nC
Q <sub>ge</sub>	Gate to	Emitter Charge		$V_{CE} = 400 \text{ V}, I_{C} = 20 \text{ A},$		-	7	-	nC
Q <sub>gc</sub>	Gate to	Collector Charge		V <sub>GE</sub> = 15 V		-	32		nC

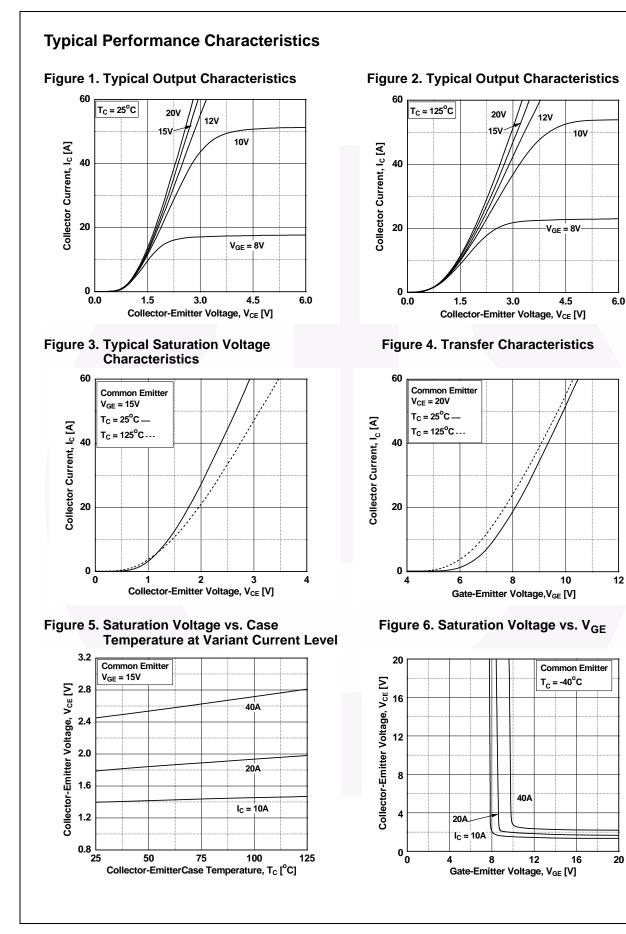
# **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.76	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	2.51	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W	

# Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Test Condition	ns	Min.	Тур.	Max	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>E</sub> = 10 A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1.9	2.5	V	
· FIM	Diodo i ormana voltago			$T_{C} = 125^{\circ}C$	-	1.7	-	
t	Diode Reverse Recovery Time		$T_C = 25^{\circ}C$	-	34	-	ns	
۲r			I <sub>F</sub> =10 A, di <sub>F</sub> /dt = 200 A/μs	$T_{C} = 125^{\circ}C$	-	57		-
Q <sub>rr</sub>	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	41	-	nC	
-11				$T_{C} = 125^{\circ}C$	-	96	-	

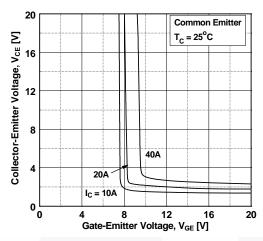
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# **Typical Performance Characteristics**

Figure 7. Saturation Voltage vs. V<sub>GE</sub>



**Figure 9. Capacitance Characteristics** 

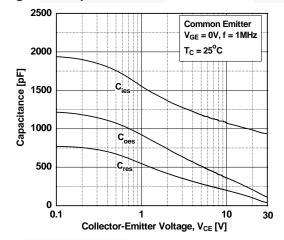


Figure 11. SOA Characteristics

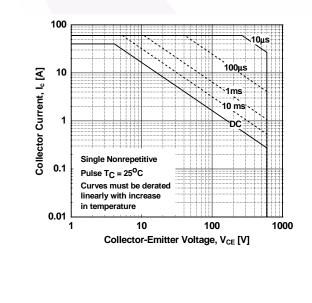


Figure 8. Saturation Voltage vs. V<sub>GE</sub>

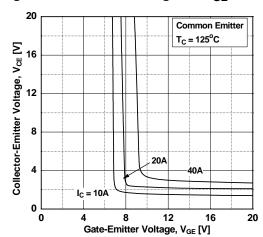


Figure 10. Gate charge Characteristics

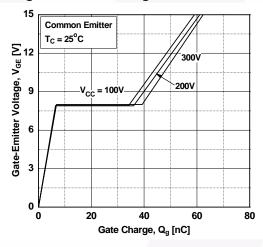
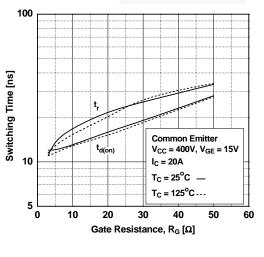
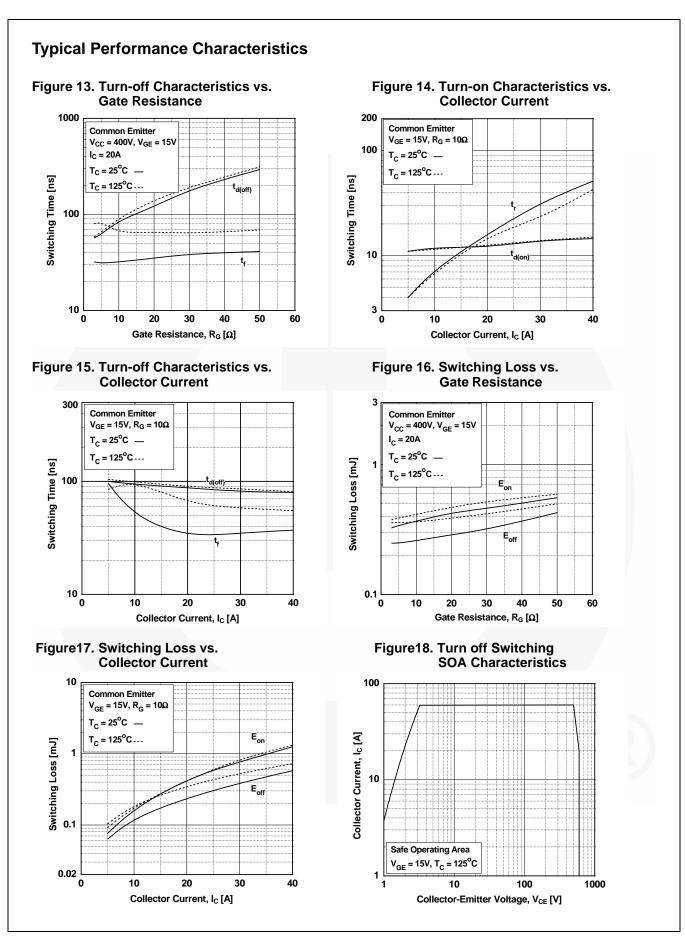
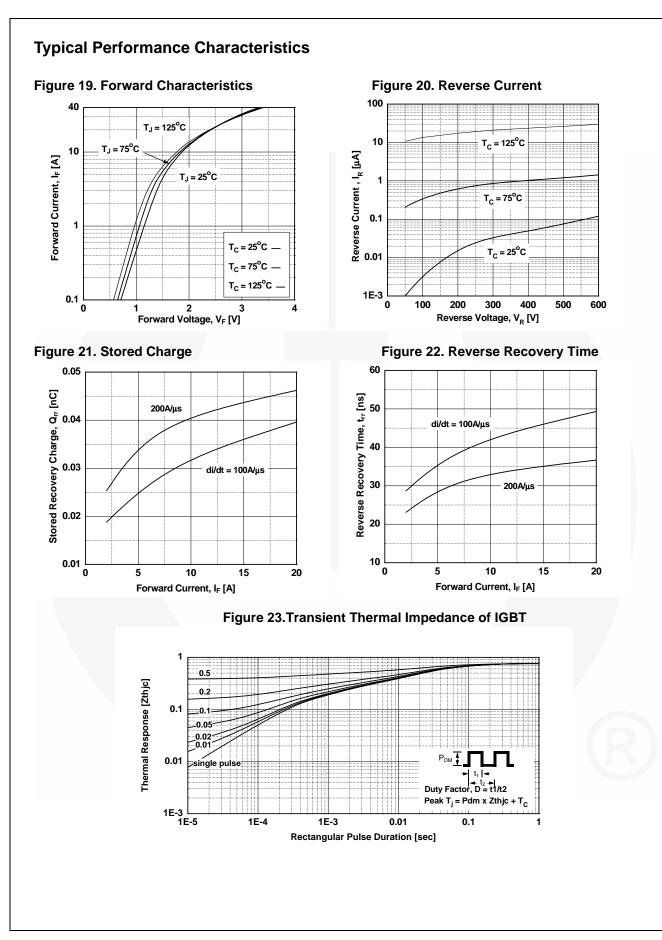


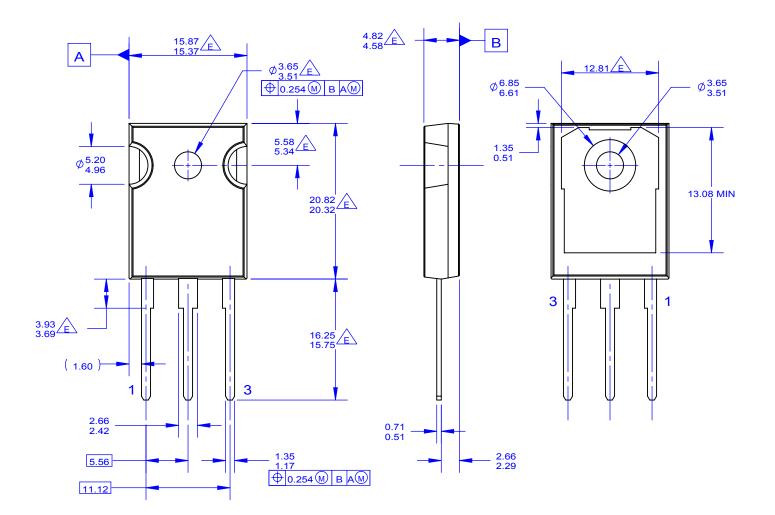
Figure 12. Turn-on Characteristics vs. Gate Resistance





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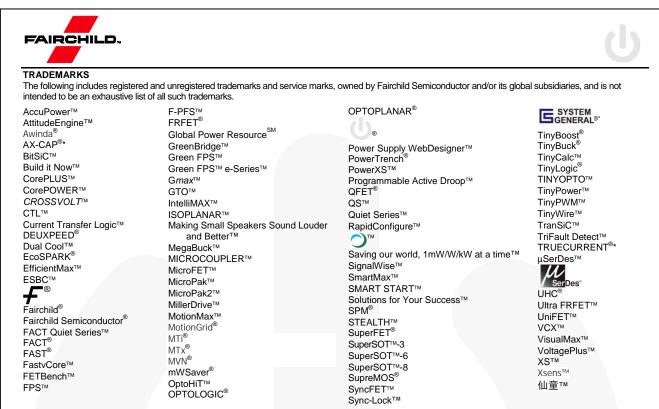




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